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December 2015

FCP165N60E

N-Channel SuperFET[®] II Easy-Drive MOSFET

600 V, 23 A, 165 mΩ

Features

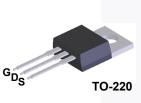
- 650 V @T_{.1} = 150°C
- Typ. R_{DS(on)} = 132 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 57 nC)
- Low Effective Output Capacitance (Typ. Coss(eff) = 204 pF)
- 100% Avalanche Tested
- · RoHS Compliant

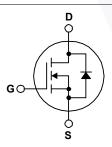
Applications

- · Telecom / Sever Power Supplies
- · Industrial Power Supplies

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET easy-drive series offers slightly slower rise and fall times compared to the SuperFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the SuperFET II MOSFET series.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCP165N60E	Unit			
V _{DSS}	Drain to Source Voltage	600	V			
V _{GSS}	Cata ta Caura Maltaga	- DC		±20	V	
	Gate to Source Voltage	- AC	AC (f > 1 Hz)			
ID	Drain Current	- Continuous (T _C = 25 ^o C)		23	^	
	Drain Current	- Continuous (T _C = 100 ^o C)		14	Α	
I _{DM}	Drain Current	- Pulsed	(Note 1)	69	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			525	mJ	
I _{AR}	Avalanche Current (Note 1)			5	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)			2.27	mJ	
dv/dt	MOSFET dv/dt	100	V/ns			
	Peak Diode Recovery dv/dt	20				
P _D	Devuer Dissingtion	(T _C = 25 ^o C)		227	W	
	Power Dissipation	- Derate Above 25°C		1.82	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

FCP165N60E Rev. C0

Symbol	Parameter	FCP165N60E	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.55	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	-0/10	

Part Nu			Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity
FCP165			TO-220	Tube	N/A		N/A	50 units	
Electrica	al Char	racteristics T _C =	= 25ºC unless (otherwise noted.					
Symbol		Parameter		Test Condit	ions	Min.	Тур.	Max.	Unit
Off Chara	cteristic	S							
	Drain to Source Breakdown Voltage			V _{GS} = 0 V, I _D = 10 mA	. T₁ = 25°C	600	-	-	V
BV _{DSS}			/oltage	$V_{GS} = 0.0$, $N_{D} = 10$ mA, $T_{J} = 150^{\circ}C$		650	-	-	V
ΔΒV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient		ture	$I_D = 10$ mA, Referenced to 25°C		-	0.7	-	V/ºC
J				V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	1
DSS	Zero Gate Voltage Drain Current		ent	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{T}_{C} = 125^{\circ}\text{C}$		-	1.46	-	μA
I _{GSS}	Gate to	Body Leakage Curre	nt	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$		-	-	±100	nA
On Charao	cteristic	S							
V _{GS(th)}	Gate T	Gate Threshold Voltage		V _{GS} = V _{DS} , I _D = 250 μA		2.5	-	3.5	V
R _{DS(on)}	Static D	Static Drain to Source On Resistance		V _{GS} = 10 V, I _D = 11.5 A		-	132	165	mΩ
9 _{FS}	Forward Transconductance			V _{DS} = 20 V, I _D = 11.5 A		-	20	-	S
Dynamic (Charact	eristics							
C _{iss}	Input Capacitance					-	1830	2434	pF
C _{oss}	Output	Capacitance		V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz		-	50	67	pF
C _{rss}	Revers	e Transfer Capacitanc	e			-	8.6	-	pF
C _{oss(eff.)}	Effectiv	Effective Output Capacitance		V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	204	-	pF
Q _{g(tot)}	Total G	Total Gate Charge at 10V		V _{DS} = 380 V, I _D = 11.5 A,		-	57	75	nC
Q _{gs}	Gate to	Source Gate Charge		V _{GS} = 10 V		-	8.3	-	nC
Q _{gd}	Gate to	Gate to Drain "Miller" Charge		(Note 4)		-	24	-	nC
ESR	Equivalent Series Resistance			f = 1 MHz		-	6	-	Ω
Switching	Charac	teristics							
t _{d(on)}	Turn-On Delay Time					-	22	55	ns
t _r	Turn-Or	n Rise Time		V _{DD} = 380 V, I _D = 11.5		-	18	46	ns
t _{d(off)}	Turn-Of	f Delay Time		V_{GS} = 10 V, R_{g} = 4.7 Ω		-	100	210	ns
t _f	Turn-Off Fall Time			(Note 4)		-	18	47	ns
Drain-Sou	rce Dio	de Characteristic	s				1		1
Is	Maximum Continuous Drain to Source Diode Forv			e Forward Current		-	-	23	Α
I _{SM}	Maximum Pulsed Drain to Source Diode F			Forward Current		-	-	69	Α
V _{SD}	Drain to Source Diode Forward Voltage		d Voltage	V _{GS} = 0 V, I _{SD} = 11.5 A		-	-	1.2	V
t _{rr}	Reverse Recovery Time			V _{GS} = 0 V, I _{SD} = 11.5 A,		-	326	-	ns
Q _{rr}	Reverse Recovery Charge			$dI_F/dt = 100 A/\mu s$		-	5.3	-	μC

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3. $I_{SD} \leq$ 11.5 A, di/dt \leq 200 A/µs, V_{DD} \leq 380 V, Starting T_J = 25°C 4. Essentially independent of operating temperature.

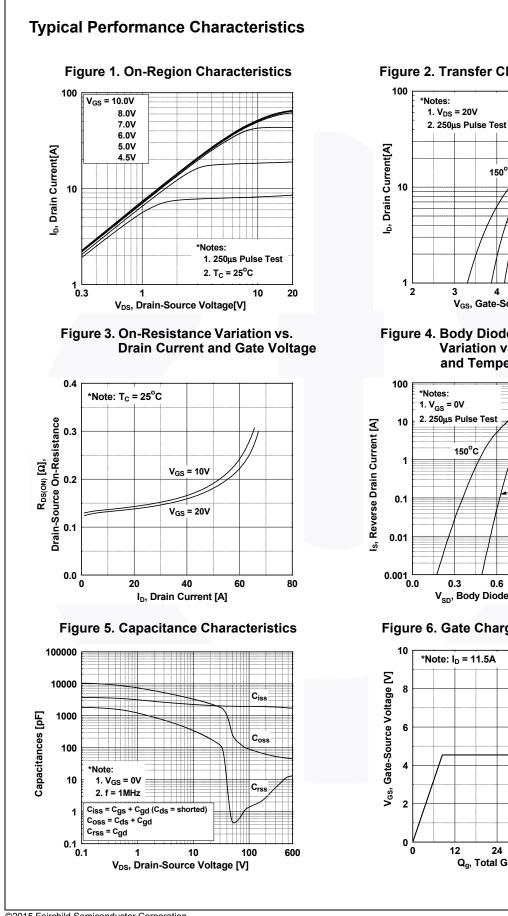
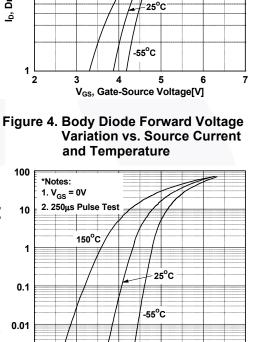
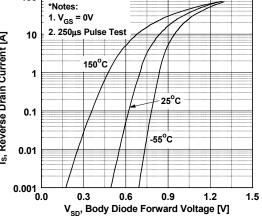
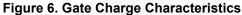


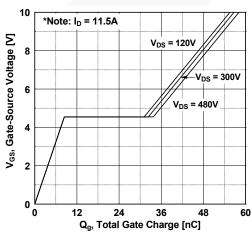
Figure 2. Transfer Characteristics

150°C

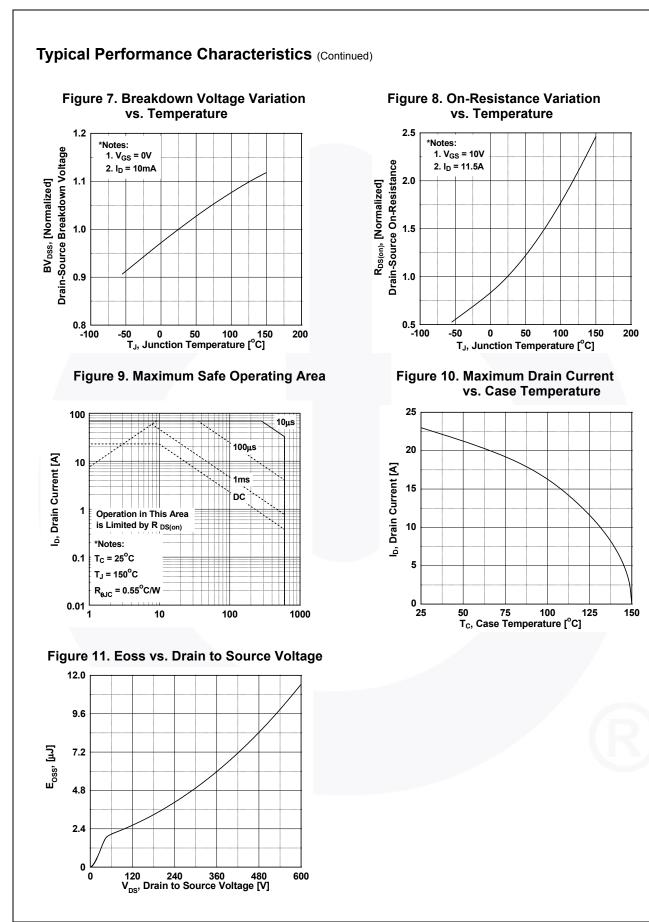


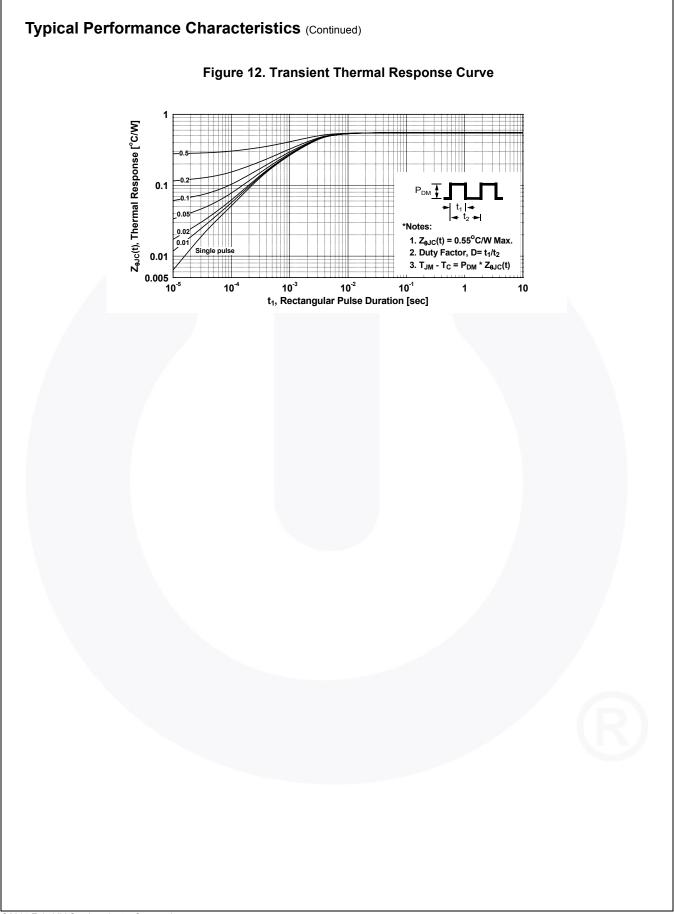


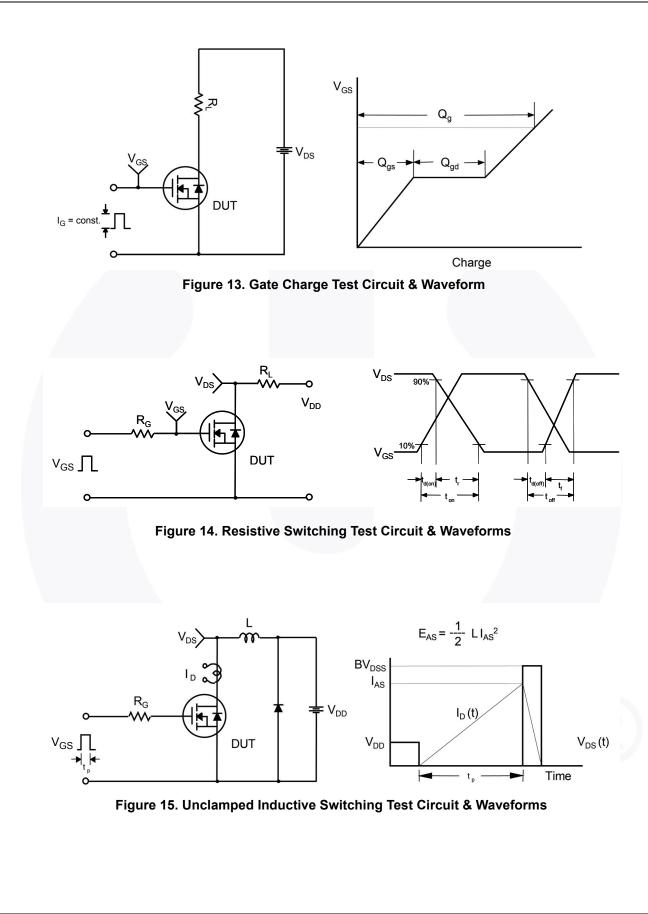




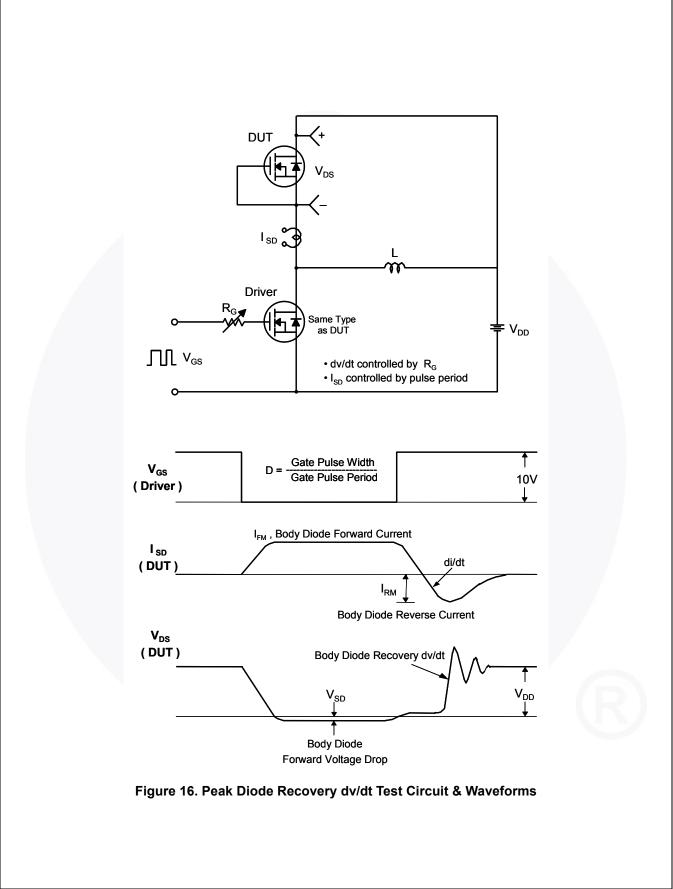
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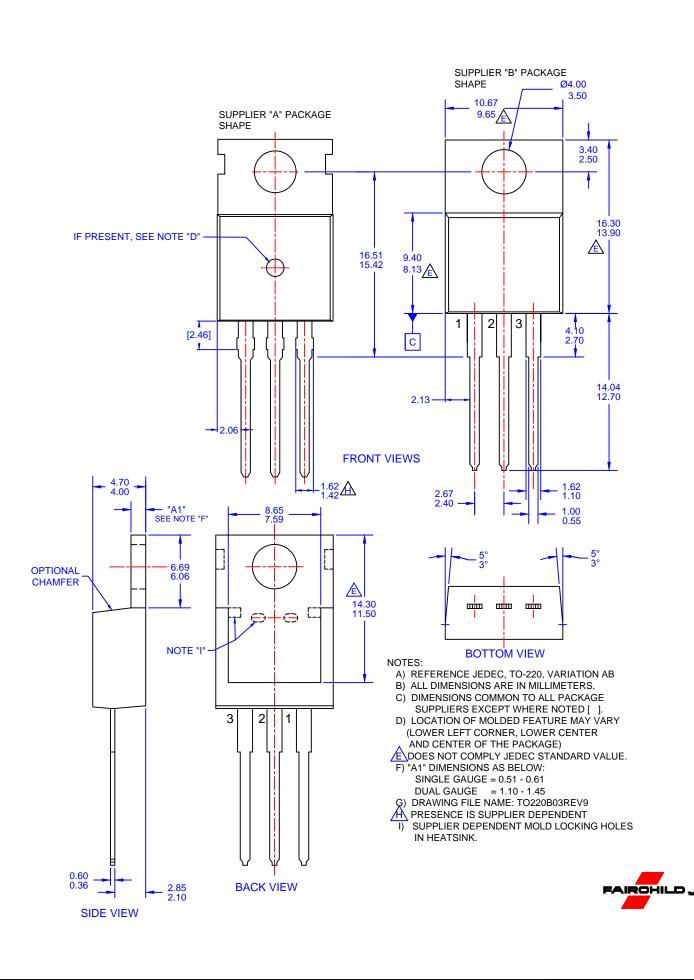






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